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Serial No.: Attached Appendix A

Name of Assignee: Shipley Company, L.L.C.
Address: 455 Forest Street
Marlborough, MA 01752

TO THE ASSISTANT COMMISSIONER FOR PATENTS

Honorable Sir:

I hereby appoint:

| | | | |
|--------------------|-----------------|--------------------|-----------------|
| Maria M. Eliseeva | Reg. No. 43,328 | David D. Lowry | Reg. No. 38,538 |
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| Peter B. Sorell | Reg. No. 44,349 | John C. Serio | Reg. No. 39,023 |
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All of the firm:

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Peter F. Corless of the law firm of Edwards & Angell, LLP, Reg. No. 33,860

as attorneys to prosecute this application, to transact all business in the Patent and Trademark Office connected with the above-referenced patent application. Applicant hereby revokes all previous powers of attorney associated with this application.

Please direct all future correspondence to the principal attorney of record as:

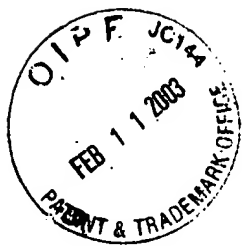
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Shipley Company, L.L.C.

By: D.P. Frickey

Darryl P. Frickey
Assistant Secretary and Director of Patents
Shipley Company, L.L.C.

Dated: January 27, 2003

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Sheet 1 of 4

APPENDIX A

| <u>Title</u> | <u>Serial Number</u> | <u>Filing Date</u> |
|---|----------------------|--------------------|
| Optical Connector System | 10/054,575 | November 13, 2001 |
| Optical Device Package for Flip-Chip Mounting | 10/013,084 | December 10, 2001 |
| Optical Device Package for Flip-Chip Mounting | 10/218,104 | August 12, 2002 |
| Structure for Aligning Chips in Stacked Arrangement | 10/013,773 | December 13, 2001 |
| Structure for Aligning Chips in Stacked Arrangement | 10/218,105 | August 12, 2002 |
| Structure for Aligning Chips in Stacked Arrangement | 10/015,271 | December 13, 2001 |
| Optical Switch Assembly with Flex Plate and Method for Making | 10/022,726 | December 20, 2001 |
| Method and Device for Passively Locating a Fiber Stub in a Groove | 10/071,871 | February 8, 2002 |
| Method for Making Optical Devices With a Moving Mask and Optical Devices Made Thereby | 10/081,995 | February 21, 2002 |
| Combined Wet and Dry Etching Process for Micromachining of Crystalline Materials | 10/071,261 | February 7, 2002 |
| Tapered Optical Fiber for Coupling To Diffused Optical Waveguides | 10/113,817 | March 28, 2002 |
| Wet and Dry Etching Process on <110> Silicon and Resulting Structures | 10/124,612 | April 17, 2002 |
| Single Mask Lithographic Process for Patterning Multiple Types of Surface Features | 09/519,165 | March 6, 2000 |

| <u>Title</u> | <u>Serial Number</u> | <u>Filing Date</u> |
|--|----------------------|--------------------|
| Solder Pads and Method of Making a Solder Pad | 10/126,491 | April 19, 2002 |
| Venting Optical Microbench | 10/135,192 | April 29, 2002 |
| V-Groove with Tapered Depth And Method for Making | 10/067,218 | February 7, 2002 |
| Optoelectronic Submount Having an On-Edge Optoelectronic Device | 10/066,299 | January 31, 2002 |
| Micromachined Structures Made by Combined Wet and Dry Etching | 10/076,858 | February 14, 2002 |
| Inductive Magnetic Recording Head Having Inclined Magnetic Read/Write Pole and Method of Making Same | 09/560,418 | April 27, 2000 |
| Optical Assembly for Coupling with Integrated Optical Devices and Method For Making | 09/987,766 | November 15, 2001 |
| Optical Device Package | 09/966,973 | September 28, 2001 |
| Submount Having Transmission Line and Method for Forming | 09/987,139 | November 13, 2001 |
| Optical Fiber Attached to a Substrate | 10/126,938 | April 19, 2002 |
| Optical Fiber with Collimated Output Having Low Back Reflection | 10/041,517 | October 18, 2001 |
| Optical Device Package Having a Configured Frame | 09/990,509 | November 21, 2001 |
| Optical Bench with Alignment Subassembly | 09/988,055 | November 16, 2001 |
| Two-Dimensional Optical Fiber Array Made from Etched Sticks Having Notches | 09/615,101 | July 13, 2000 |

| <u>Title</u> | <u>Serial Number</u> | <u>Filing Date</u> |
|--|-----------------------------|---------------------------|
| Optical Fiber Array for Preventing Flow of Glue Between Fibers and Waveguide | 09/713,117 | November 15, 2000 |
| Optoelectronic Packages Having Insulation Layers | 09/824,205 | April 3, 2001 |
| Methods and Devices for Coupling Optoelectronics Packages | 09/827,183 | April 6, 2001 |
| Open Face Optical Fiber Array For Coupling to Integrated Optic Waveguides and Optoelectronic Submounts | 09/614,155 | July 11, 2000 |
| Fiber Optic Array Switch | 09/833,282 | April 12, 2001 |
| Optoelectronic Device-Optical Fiber Connection having Micromachined Pit for Passive Alignment of the Optoelectronic Device | 10/192,752 | July 10, 2002 |
| Wafer Level Packaging for Optoelectronic Devices | 09/999,517 | October 24, 2001 |
| Single-Piece Alignment Frame For Optical Fiber Arrays | 09/825,990 | April 5, 2001 |
| Single-Piece Alignment Frame For Optical Fiber Arrays | 10/208,090 | July 30, 2002 |
| Fiber Array with V-Groove Chip And Mount | 10/037,971 | October 24, 2001 |
| Microchip Having Grayscale and Micromachined Features and Single Mask Process for Patterning Same | 09/999,332 | October 26, 2001 |
| Multi-Level Lithography Masks | 09/853,250 | May 9, 2001 |
| Embedded Waveguide with Alignment Grooves and Method for Making Same | 09/978,804 | October 15, 2001 |

Title

Serial Number

Filing Date

Variable Width Waveguide for Mode-Matching and Method for Making

09/983,984

October 26, 2001

#1176909 - 23091/5



09/519, 100

AF/1772

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February 4, 2003

Assistant Commissioner for Patents
Washington, DC 20231

CERTIFICATE OF MAILING

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to the: Assistant Commissioner of Patents, Washington, DC 20231 on:

By:


Deborah Celeste


Date

**RE: Power of Attorney
Shipley Company, LLC**

Dear Sir:

Enclosed herewith are the following documents:

1. Power of Attorney with Appendix A; and
2. Return Postcard.

Please charge Deposit Account 50-0369 for any fees that may be required.

Very truly yours,

By:



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